

产品承认书 SPECIFICATION FOR APPROVAL

CUSTOMER 快司科号: XRIM404020S1R5MGCA 敗司品名: Miniaturized integrated inductor DUR PART NAME 数量: 0PCS 送样日期: 数量: 0PCS Arte SAMPLES								
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Liu Jialing Rao ping Li Zhengxiong 客户确认 CUSTOMER APPROVE 客户名称 CUSTOMER NAME: 客户科号 CUSTOMER P/N: 與格型号 DESCRIPTION: measure 404020 nductance: 1. 5uH 检查結果: □ 合格 □不合格 签名及盖章: INSPECT RESULT ACCEPT		制造矿	确认 MAN	UFACTURE	R APPROV	Е		
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说明 REMARK:	INSPECT RESU	LT ACCE	CPT REJ	ECT	SIGNATU	RE AND STAMP		
	说明 REMARK:							

如对本承认书内容有异议请提出或标记发送至我司,本承认书在未收到异议回复时于本承认书提供一周后生效。

If you have any objection to the contents of this acknowledgement, please put forward or mark it and send it to our company. This acknowledgement will take effect one week after it is provided if you do not receive an objection reply.

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1. <u>Scope</u>

Featurs

- 11 Metal material for large current and low loss.
- 2 High performance (Isat) realized by metal dust core.
- B Low loss realized with low Rdc.
- 4 Closed magnetic circuit design reduces leakage flux.
- 5 Vinyl thermal spray, better surface compactness.
- 16 Environmental requirements must comply with the QESP-44 document
- 17 100% lead (Pb) free meet RoHS2.0 and Halogen, Reach and other legal and regulatory requirements standard.

Application

- 2.1 DC/DC converters.
- 2.2 Pad,Smart phone.
- 2.3 Portable gaming devices, Smart wear, Wi-Fi module.
- 2.4 Notebooks, VR, AR.
- 2.5 LCD displays, HDDs, DVCs, DSCs, etc.
- 2.6 Baseband power supply, Amplifier, Power management, Module power supply, Camera power manageme.

2. Ordering Procedure

XRIM	4040	20	S	1R5	Μ	G	С	Α
1	2	3	4	5	6	\bigcirc	8	9

DSeries Name: Mini Molding Power Inductors

②External Dimensions(L×W):4040=4.0*4.0 mm

③External Dimensions(H):20=2.0 mm

④Size Tolerance:S=±0.2mm

⑤Inductance value:1R5=1.5uH

Tolerance:M=±20%

⑦Coating color:G=Gray

Product type:C=Common

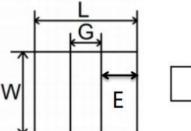
Special define:A=Routine

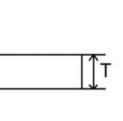
For special characteristics, please refer to the specific values in Item 5 "Specifications".

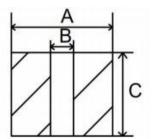


3. SHAPE AND DIMENSIONS

Outline Dimensions







Recommend Land Pattern Dimensions

Units:mm

Series	L	G	W	Е	Т	Α	В	С
XRIM4040203	4.1 ± 0.2	1.3 ± 0.2	4.1 \pm 0.2	1.40 ± 0.2	2.00Max.	4.10	1.10	4.10

4. Marking

No Marking

5. <u>Specifications</u>

P/N	L0(µH)	$Rdc(m\Omega)$		Heat rating current Irms(A)		Saturation current Isat(A)	
	@ (0A) 1MHz	Typical	Max	Typical	Max	Typical	Max
XRIM404020S1R5MGCA	1.5	18	22	6.0	5.5	10.5	9.5

Test remarks

Note 1.: All test data is referenced to 25 °C ambient.

Note 2.: Test Condition:1MHz, 1.0Vrms.

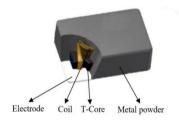
Note 3.: Irms:DC current (A) that will cause an approximate ΔT of 40 °C.

Note 4.: Isat:DC current (A) that will cause L0 to drop approximately 30%.

Note 5.: Operating Temperature Range -55° C to $+ 125^{\circ}$ C.

- Note 6.: The part temperature (ambient + temp rise) should not exceed 125 under °C the worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the endapplication.
- Note 7.: The rated current as listed is either the saturation current or the heating current depending on which value is lower.

6. Structure



7. Current Characteristic





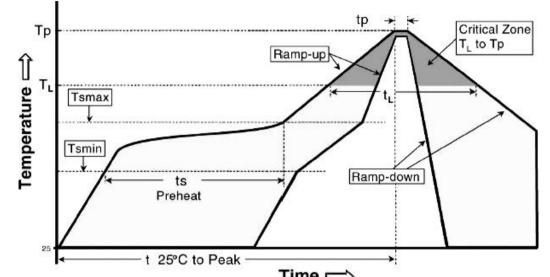
8. <u>Reliability</u>

Item	Requirements	Test Methods and Remarks
Insulation Resistance	≥100MΩ	100 VDC between inductor coil and The middle of the top surface of the body for 60 seconds.
Solderability	90% or more of electrode area shall be coated by new solde.	Dip pads in flux . Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free). Solder Temperature: $245 \pm 5^{\circ}$ C. Immersion Time: (5 ± 1) s.
Resistance to Soldering Heat	No visible mechanical damage. Inductance change: Within ±10%.	Dip pads in flux. Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free). Solder Temperature: 260±5°C. Immersion Time: 10±1sec.
Adhesion of teral electrode	Strong bond between the pad and the core, without come off PCB.	Inductors shall be subjected to $(260\pm5)^{\circ}$ C for (20 ± 5) s Soldering in the base whit 0.3mm solder. And then aplombelectrode way plus tax 12 N for (10±1) seconds.
High temperature	No case deformation or change in appearance. Inductance change: Within ±10%	Temperature: 125±2°C. Time : 1000 hours. Measurement at 24±4 hours after test conclusion.
Low temperature	No visible mechanical damage. Inductance change: Within ±10%	Temperature: -55±2°C. Time : 1000 hours. Measurement at 24±4 hours after test conclusion.
Thermal shock	No visible mechanical damage. Inductance change: Within ±10%	The test sample shall be placed at (-55±3)°C and (125±3)°C for (30±3), different temperature conversion time is 2~3 utes. The temperature cycle shall be repeated 32 cycles. Placed at room temperature for 2 hours, within 48±4 hours of testing.
Temperature characteristic	Inductance change Pc-b,Pc-d: Within ±10%	a: +20 °C (30~45) → b: -40 °C (30~45) → c: +20 °C (30~45) → d: +125 °C (30~45) → e: +20 °C (30~45) → e: +20 °C (30~45) $P_{c-b} = \frac{L_b - L_c}{L_c} \times 100\%$ $P_{c-d} = \frac{L_d - L_c}{L_c} \times 100\%$
Static Humidity	No visible mechanical damage. Inductance change: Within ±10%	Inductors shall be subjected to (95 ± 3) %RH . at (60 ± 2) °C for (1000 ± 4) h. Placed at room temperature for 2 hours, within 48 hours of testing.
Life	No visible mechanical damage. Inductance change: Within ±10%	Inductors shall be store at (85±2)°C for (1000±4) hours with Irms applied. Placed at room temperature for 2 hours, within 48 hours of testing



9. Soldering Condition

(This is for recommendation, please customer perform adjustment according to actual application) Recommend Reflow Soldering Profile : (solder : Sn96.5 / Ag3 / Cu0.5)



Profile Feature	Lead (Pb)-Free solder
Preheat:	
Temperature Min(Ts _{min})	150°C
Temperature Max (Ts _{max})	200°C
Time $(Ts_{min} \text{ to } Ts_{max})(ts)$	60 -120 seconds
Average ramp-up rate:	
(Ts max to Tp)	3°C / second max.
Time maintained above :	
Temperature (TL)	217°C
Time (t _L)	60-150 seconds
Peak Temperature (Tp)	260°C
Time within ${}^{+0}$ °C of actual peak Temperature (tp) ² -5	10 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8minutes max.

Allowed Re-flow times : 2 times

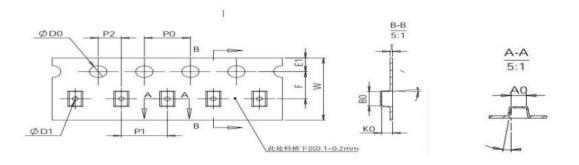
Remark : To avoid discoloration phenomena of chip on terminal electrodes, please use N2 Re-flow furnace .



10. Packing

101 Dimension of plastic taping: (Unit: mm)

The following dimensions are related to the actual fit of the machine, for reference only.

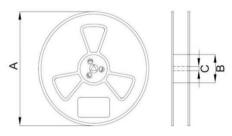


Series	W	A0	BO	D0	D1	E
tolerance	/	/	/	+0.1/-0	±0.20	±0.10
404020	12.0±0.30	4.40±0.10	4.40±0.10	1.5	1.5	1.75

Series	F	К0	PO	P2	P1	Т	package
tolerance	±0.10	/	±0.10	±0.10	±0.10	±0.05	quantity
404020	5.5	2.20±0.10	4.0	2.0	8.0	0.30	ЗK

102 Dimension of Reel : (Unit: mm)

Туре	A	B	С
	±2.0	±2.0	±2.0
All	178	60	13



11. <u>Note</u>

- 111 recommend products store in warehouse with temperature between 15 to 35°C under humidity between 25 to 75%RH. Even under storage conditions recommended above, solder ability of products will be degraded stored over 1 yearold.
- 12 Cartons must be placed in correct direction which indicated on carton, otherwise the reel or wire will be deformed.
- 1B Storage conditions as below are inappropriate:
 - a. Stored in high electrostatic environment
 - b. Stored in direct sunshine, rain, snow or condensation.
 - c. Exposed to sea wind or corrosive gases, such as Cl₂, H₂S, NH₃, SO₂, NO₂, etc.
- 14 The products are used in circuit board thickness greater than 1.6mm. If customers use less than the thickness of the circuit board that you should confirm with the company, in order to recommend a more suitable product.

12. <u>Record</u>

Version	Description	Page	Date	Amended by	Checked by
A0	First version	1~5	Nov.6.2023	Chen.Zhang	Congdian.Lu